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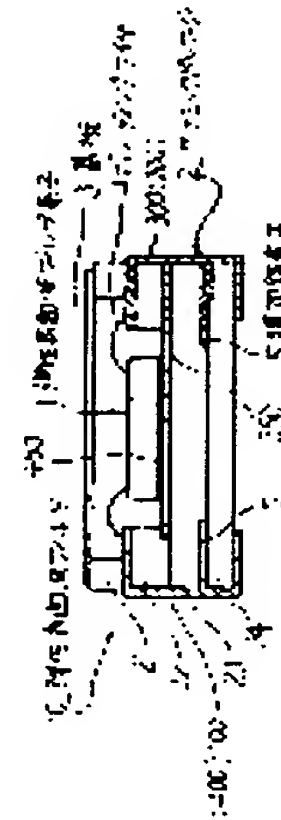
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SATO YOSHIO**(54) SURFACE ACOUSTIC WAVE FILTER****(57)Abstract:**

PURPOSE: To contrive miniaturization by providing an impedance matching circuit composed of plural film circuit elements on the inner and outer exposure faces of a package or between the layers of the ceramic package.

CONSTITUTION: An impedance matching circuit composed of plural film circuit elements 5 is provided on the inner and outer exposure faces of the package 2 or between the layers of the ceramic package 2 to constitute this surface acoustic wave filter 10. Since the impedance matching circuit is integrated with the ceramic package 2 with the plural film circuit elements 5 provided between the layers of the ceramic package 2 or the inner and outer exposure faces of the package 2 in such a manner, it is not required to add another impedance matching circuit at the outside to constitute the filter circuit and the entire size of the filter circuit 10 is miniaturized.

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